

2 - 20 GHz 23dBm MMIC

FEATURES

- Small Chip Size: 43.6 mils x 90 mils
- P₋₁ dB: 23 dBm typical
- Small Signal Gain: 11.5 dB typical
- Bias Condition: 250 mA @ 8 V
- Single Bias supply

DESCRIPTION

The TC1901 is a broadband general-purpose medium power MMIC amplifier that operates in 2 to 20 GHz frequency range. The amplifier provides a 11.5 dB of typical gain and delivers 23 dBm of typical output power. The MMIC is fabricated using a mature GaAs PHEMT process. The process features all passivation for increased performance and reliability. All devices are 100% DC tested to assure consistent quality. Bond pads are gold plated for either thermocompression or thermosonic wire bonding. Backside gold plating is compatible with standard AuSn die-attach.

ELECTRICAL SPECIFICATIONS (at 25 °C)

- For full 2-20GHz freq band -

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNITS |
|--------------------------|---------------------------------------|------|-------|-------|-------|
| FREQ | Frequency Range | 2 | | 20 | GHz |
| SSG | Small Signal Gain | 10 | 11.5 | | dB |
| GOF | Small Signal Gain Flatness | | ± 0.6 | ± 0.8 | dB |
| P₋₁ dB | Output Power at 1 dB Gain Compression | 21.5 | 22.5 | | dBm |
| IP3 | Third Order Intercept Point | | 30 | | dBm |
| VSWR, IN | Input VSWR | | 2:1 | | - |
| VSWR, OUT | Output VSWR | | 2:1 | | - |
| VDD | Supply Voltage | | 8 | | Volt |
| IDD | Current Supply | | 250 | | mA |

ELECTRICAL SPECIFICATIONS (at 25 °C)
- For 2-8GHz / 8-14GHz / 14-20GHz bands -

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
|-------------------------|-----------------------------|-----------|------|------|------------|------|------|-------------|------|------|-------|
| FREQ | Frequency Range | 2.0 - 8.0 | | | 8.0 - 14.0 | | | 14.0 - 20.0 | | | GHz |
| SSG | Small Signal Gain | 10 | 11.5 | | 10 | 11.5 | | 10.5 | 12 | | dB |
| GOF | Small Signal Gain Flatness | | ±0.5 | | | ±0.5 | | | ±0.5 | | dB |
| GOT | Gain Variation Over Temp. | | 0.01 | 0.02 | | 0.01 | 0.02 | | 0.01 | 0.02 | dB/°C |
| NF | Noise Figure | | 3.75 | | | 3.75 | | | 3.75 | | dB |
| P_{-1dB} | | 23.5 | 24.5 | | 22.5 | 23.5 | | 21.5 | 22.5 | | dBm |
| IP3 | Third Order Intercept Point | | 32 | | | 31 | | | 30 | | dBm |
| VSWR, IN | Input VSWR | | 2:1 | | | 2:1 | | | 2:1 | | - |
| VSWR, OUT | Output VSWR | | 2:1 | | | 2:1 | | | 2:1 | | - |
| VDD | Supply Voltage | | 8 | | | 8 | | | 8 | | Volt |
| IDD | Current Supply | | 250 | | | 250 | | | 250 | | mA |
| OTR | Operating Temp. Range | -45 | | 85 | -45 | | 85 | -45 | | 85 | °C |

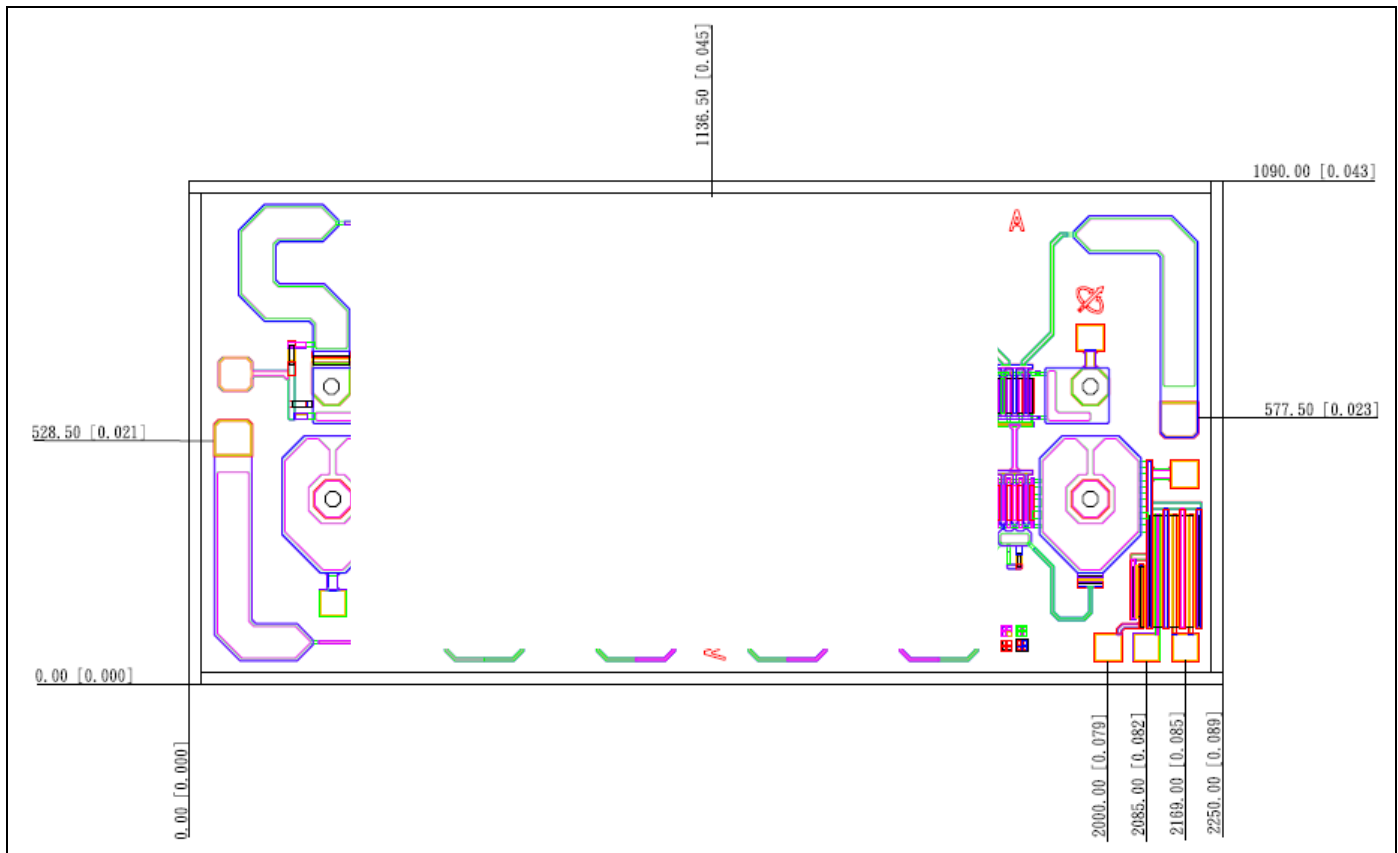
ABSOLUTE MAXIMUM RATINGS(at 25 °C)

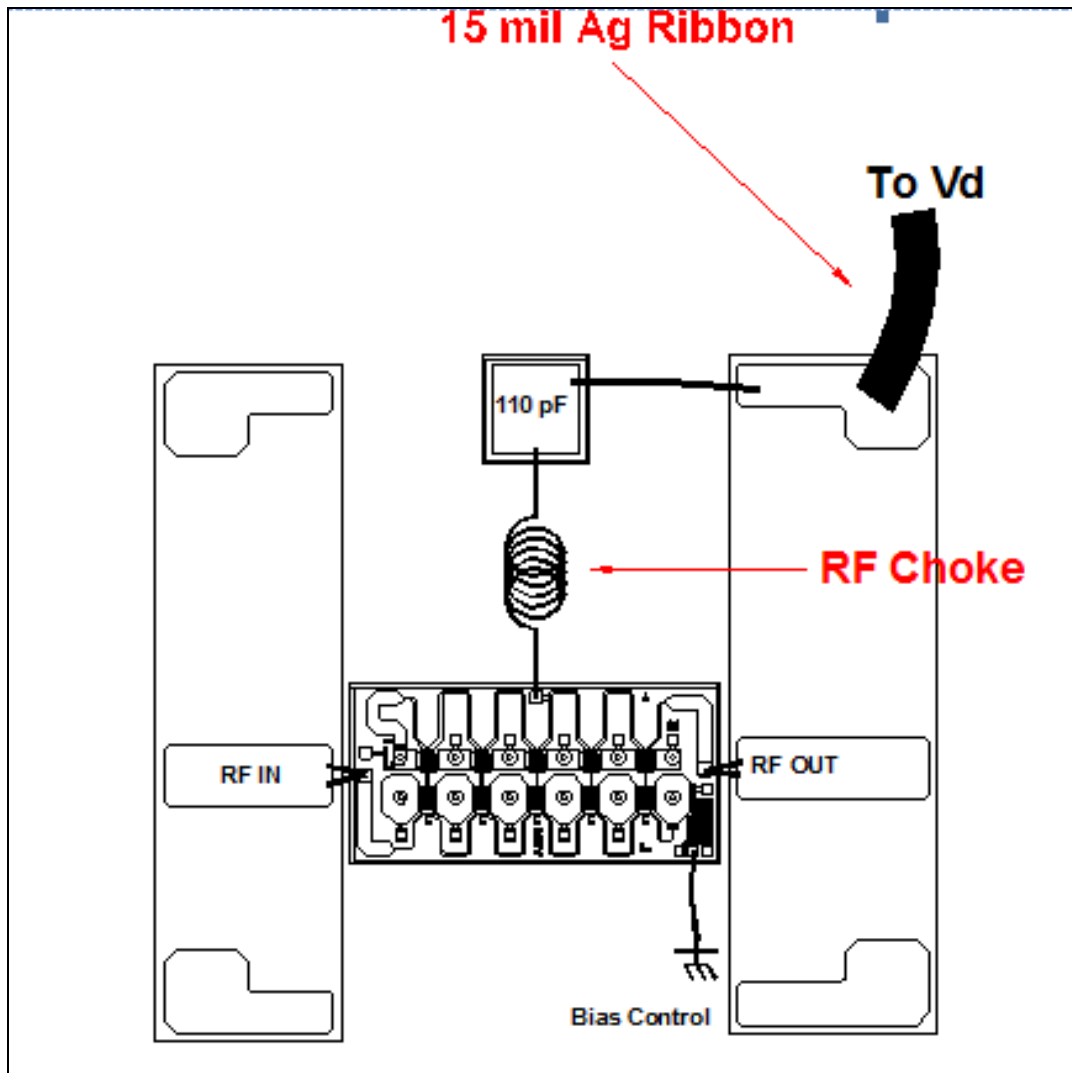
| Symbol | Parameter | Rating |
|------------------|------------------------------|--------------------|
| V _{DS} | Drain-Source Voltage | +12 V |
| I _D | Drain Current | 350mA |
| P _T | Continuous Power Dissipation | 3W |
| P _{in} | Input Power | +23dBm |
| T _{ch} | Channel Temperature | +175°C |
| T _{STG} | Storage Temperature | - 50 °C to +150 °C |

MECHANICAL OUTLINE

Units: micrometer (inch)

Thickness: 76.2 (0.003)

 Chip Size: ± 58 (0.002)


ASSEMBLY DIAGRAM

Note:

1. Rs tuning Pads are for gate bias control.
2. The left pad can get lower I_{ds} and the right pad can get higher I_{ds} .
3. Using 0.7mil Au wire except marked specially.